

VENUE

The conference venue is in the campus of the Institut Teknologi Bandung, Bandung, Indonesia. Address: Jalan Ganesa 10, Bandung 40132, Tel: +62-22-2534185 Fax: +62-22-2534185. Website: <http://www.stei.itb.ac.id>

IMPORTANT DATES

Abstract Due Date: March 10, 2007
Manuscript Due Date: April 30, 2007
Deadline Pre-registration: May 15, 2007

CONFERENCE: June 17 - 19, 2007

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ICEEI 2007 SECRETARIAT

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CALL FOR PAPERS

ICEEI 2007 International Conference on Electrical Engineering and Informatics



**June 17 - 19, 2007
Institut Teknologi Bandung
Bandung, Indonesia**

Organizer:

School of Electrical Engineering and Informatics,
Institut Teknologi Bandung, Indonesia

Co-Organizer:

Faculty of Information Science and Technology,
Universiti Kebangsaan Malaysia, Malaysia

Sponsor:

IEEE Indonesia Section



The International Conference on Electrical Engineering and Informatics (ICEEI2007) will be held in Bandung, Indonesia on June 17 - 19, 2007. This conference is an international event organized by the School of Electrical Engineering and Informatics, ITB, Indonesia and co-organised by Faculty of Information Science & Technology, UKM, Malaysia. The purpose of this conference is to provide a forum for researchers, scientists and engineers from all over the world to exchange ideas and discuss recent progress in all fields of electrical engineering and informatics from basic science to practical applications. The organizing committee cordially invites you to participate in the conference.

Topics

The scopes of the conference are Power Engineering, Telecommunication, Control Engineering, Information Technology, Electronics, Informatics, Data Base and Software Engineering, Biomedical Engineering and Computer Engineering

Original papers on the following topics, but not limited to, are welcome to be submitted:

1. Fundamental and Education
2. Power Systems and Energy
3. High Voltage Engineering and Insulation Technologies
4. Electrical Machines, Power Electronics & Industry Applications
5. Electromagnetic Compatibility
6. Communication Systems
7. Radar and Its Applications
8. Satellite Communication
9. Antenna and Propagation
10. Broadcasting Technology
11. Signal Processing in Communications
12. Wireless and Mobile Communication
13. Control Theory and Application
14. Computer Vision and Robotics
15. Computer Architecture Design
16. Pervasive Computing and Network
17. Real Time and Embedded Systems
18. Parallel and Distributed Computing
19. Operating Systems
20. Intelligent System
21. Network Management and Security
22. Sensors and Telemetry System
23. VLSI and IC Design
24. Industrial Electronics
25. Audit, Security and Governance

26. Knowledge Management
27. Information Systems
28. Software Engineering
29. Learning Systems
30. Animation Systems
31. Information Technology Application
32. IT Management and Assurance
33. Digital Right Management
34. Database and Programming
35. Data Mining
36. Multimedia Services and Applications
37. Image Processing
38. Biomedical Instrumentation
39. Biomedical Imaging and Image Processing
40. Bioinformatics and Telemedicine
41. Biomaterials, Tissue Engineering and Drug Delivery Systems
42. Biomechanics and Rehabilitation Engineering

Language

English is the official language of the conference. All documents must also be written in English.

Submission of Abstract

You are invited to submit an abstract of about 250 words to the Conference Secretariat by March 10, 2007 via e-mail or airmail. The abstract must include title, author's name(s), affiliation(s), mailing and e-mail addresses, telephone and fax numbers. The abstract should be in Microsoft Word format. Acceptance or rejection of abstract(s) will be notified by late March 2007 to the corresponding author.

Submission of Full Paper

The authors of the accepted papers are requested to submit camera-ready manuscripts by April 30, 2007. The author's kit and detailed instructions for paper preparation and submission will be announced in the conference website (<http://www.iceei2007.com>) and/or to the authors in other convenient way. All accepted papers will be published in the Conference Proceedings.

Invited Lectures and Special Sessions

Invited and Samaun memorial lectures by distinguished researchers are planned. Special sessions on topics in electrical engineering and informatics are also planned.

	(In USD)	
	By May 15, 2007	After May 15, 2007
Regular	250	300
Student	150	175
Accompany	75	75

The registration fees include all conference materials, conference proceedings, admissions to all sessions, welcoming reception, banquet, lunches, and coffee breaks.